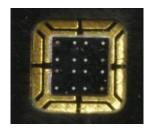
Surface Mount Quad Photodiode

OPR5911



Features:

- Surface mountable
- Closely matched responsivity
- High temperature operation
- Common cathode connections



Description:

Each OPR5911 device is a four-element photodiode that is enclosed in a compact polyimide chip carrier and designed for a variety of encoder and control applications. The single chip construction ensures excellent matching and very tight dimensional tolerances between active areas. The custom opaque package shields the photodiodes from stray light and can withstand multiple exposures to the most demanding soldering conditions, while the wraparound gold-plated solder pads offer exceptions storage and wetting characteristics.

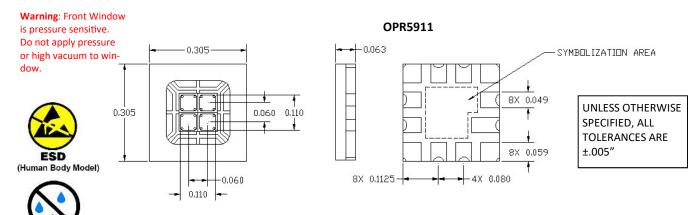
All cathodes in the OPR5911 are bonded together, which enables the elements to act in unison with limited external circuitry.

See Application Bulletin 237 for handling considerations.

Applications:

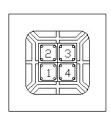
- Encoder applications
- Control applications

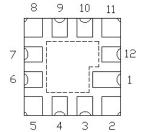
| Ordering Information | | | | | | | |
|----------------------|------------------|------------------|---------------------------|----------------------|-------------------|-----------|--|
| Part Number | Receiver Type | # of Elements | Responsivity (mA/mW) Min. | Reverse Voltage Min. | Active Area (mm²) | Packaging | |
| OPR5911 | Photodiode Array | 4 | 0.45 | 14 | 1.61 (each) | Chip Tray | |





MOISTURE





| Pin # | Function | Pin # | Function |
|-------|----------------|-------|----------------|
| 1 | Anode 1 | 7 | Anode 3 |
| 2 | Common Cathode | 8 | Common Cathode |
| 3 | N. C. / N.C. | 9 | N. C. / N.C. |
| 4 | N. C. / N.C. | 10 | N. C. / N.C. |
| 5 | Common Cathode | 11 | Common Cathode |
| 6 | Anode 2 | 12 | Anode 4 |

General Note

TT Electronics reserves the right to make changes in product specification without notice or liability. All information is subject to TT Electronics' own data and is considered accurate at time of going to print.

Surface Mount Quad Photodiode

OPR5911



Electrical Specifications

Absolute Maximum Ratings (T_A = 25° C unless otherwise noted)

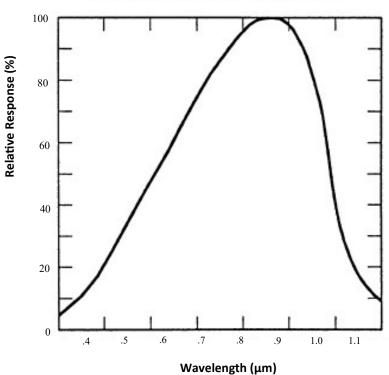
| Storage and Operating Temperature | -55° C to +125° C | |
|--|-------------------|--|
| Reverse Breakdown Voltage | 14 V / minute | |
| Solder reflow time within 5°C of peak temperature is 20 to 40 seconds ⁽¹⁾ | 250° C | |

Electrical Characteristics (T_A = 25° C unless otherwise noted)

| SYMBOL | PARAMETER | MIN | TYP | MAX | UNITS | TEST CONDITIONS |
|----------------|---------------------------|------|------|-----|-------|---|
| R | Responsivity | 0.45 | ı | ١ | A/W | $E_e = 10 \mu W$, $\lambda = 850 nm$, $V_R = 0$ |
| V_{BR} | Reverse Breakdown Voltage | 14 | - | 1 | V | Ι _R = 100 μΑ |
| I _D | Reverse Dark Current | _ | _ | 30 | nA | V _R = 10 V |
| C _T | Capacitance | _ | 10 | - | pF | V _R = 10 V |
| LXW | Active Area (per diode) | _ | 1.61 | | mm² | (1.27 mm x 1.27 mm) |

Notes:

Spectral Responsivity



^{1.} Solder time less than 5 seconds at temperature extreme.

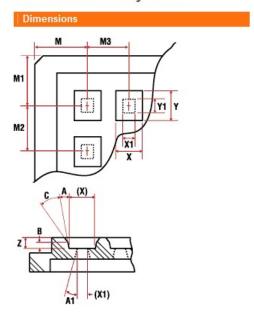
Surface Mount Quad Photodiode

OPR5911



Packaging

Bare Die/CSP Tray Detail



rackayılış

| - 14 | 111 | . " | - | α_{-} | 6 | 7 | c | n | - |
|------|-----|-----|---|--------------|---|---|---|---|---|
| | 44- | . 0 | 0 | 9- | o | _ | u | u | 1 |

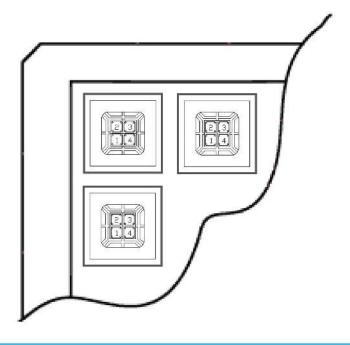
| UNIT OF MEAS | URE |
|---------------------------|-----|
| English | |
| Metric | |

| M | = 0.592" ±0.005" |
|-------|-------------------------------|
| M1 | = 0.592" ±0.005" |
| M2 | = 0.401" ±0.005" |
| МЗ | = 0.401" ±0.005" |
| Array | =8x8 (64) |
| POCKE | T DETAILS |
| Х | = 0.361" ±0.005" pocket size |
| Υ | = 0.361" ±0.005" pocket size |
| Z | = 0.100" ±0.005" pocket depth |
| Α | = 5° ±1/2° pocket draft angle |
| | No Cross Slots |
| OVERA | LL TRAY SIZE |
| Size | = 3.990" ±0.010" |

Orientation

Flatness = 0.020"

Height = 0.315" +0.005" -0.005"



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